

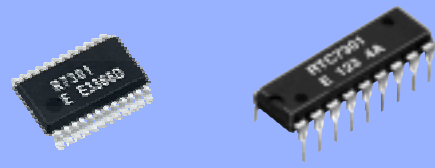
4-bit REAL TIME CLOCK MODULE

RTC - 7301SF / DG

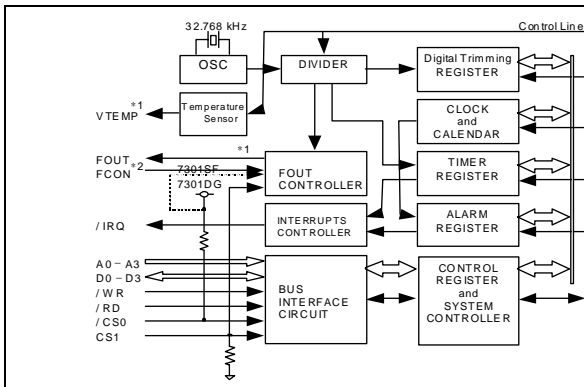
- Built-in crystal unit 32.768 kHz with frequency adjusted
- Frequency selectable clock output (32.768 kHz to 1/30 Hz)
- Built-in 30 second adjustment function, digital pace adjustment function (Max. adjustment:  $\pm 192 \times 10^{-6}$ )
- Built-in alarm and timer interrupt functions.
- Built-in semiconductor temperature sensor (Voltage output: -7.8 mV / °C, RTC-7301SF)
- Operating voltage range: 2.4 V to 5.5 V, time keeping voltage range: 1.6 V to 5.5 V
- Low current consumption (0.6  $\mu$ A / 3 V Typ.)
- High speed parallel interface compatible with SRAM



Product Number (Please contact us)  
 RTC-7301SF : Q42730181000200  
 RTC-7301DG : Q42730111000200



Block diagram



This is a block diagram for RTC-7301SF.

Be aware that RTC-7301DG differs according to the following 2 points.

- \* 1) The VTEMP output is not connected to an external pin.
- \* 2) The FCON input pin is not connected to an external pin, but is fixed at "H" internally.

External dimensions/Terminal connection

(Unit:mm)

● RTC-7301SF (SSOP 24-pin)

No.	Pin terminal	No.	Pin terminal
1	/CS0	24	VDD
2	FCON	23	(VDD)
3	FOUT	22	(VDD)
4	VTEMP	21	(VDD)
5	(VDD)	20	(VDD)
6	/IRQ	19	(VDD)
7	A0	18	CS1
8	A1	17	D0
9	A2	16	D1
10	A3	15	D2
11	/RD	14	D3
12	GND	13	/WR

● RTC-7301DG (DIP 18-pin)

No.	Pin terminal	No.	Pin terminal
1	/CS0	18	VDD
2	FOUT	17	(VDD)
3	/IRQ	16	(VDD)
4	A0	15	CS1
5	A1	14	D0
6	A2	13	D1
7	A3	12	D2
8	/RD	11	D3
9	GND	10	AVR

Specifications (characteristics)

\*Refer to application manual for details.

■ Absolute Max. rating GND=0 V

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	V <sub>DD</sub>	V <sub>DD</sub> to GND	-0.3	+7.0	V
Input voltage	V <sub>IN</sub>	Input terminal, Do to D <sub>3</sub> pins	GND-0.3	V <sub>DD</sub> +0.3	
Output voltage(1)	V <sub>OUT1</sub>	/IRQ pin		+8.0	
Output voltage(2)	V <sub>OUT2</sub>	FOUT, D <sub>0</sub> -D <sub>3</sub> , VTEMP pin	V <sub>DD</sub> +0.3		
Storage temperature	T <sub>STG</sub>	Stored as bare product after unpacking	-55	+125	°C

■ DC characteristics (GND=0 V, V<sub>DD</sub>=1.6 V to 5.5 V, T<sub>a</sub>=-40 °C to +85 °C)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	
Current consumption (When non-accessed) FOUT = Output OFF VTEMP = Output OFF	I <sub>DD1</sub>	/CS <sub>0</sub> , /RD, /WR = V <sub>DD</sub> A <sub>0</sub> -A <sub>3</sub> , CS <sub>1</sub> = GND D <sub>0</sub> -D <sub>3</sub> , /IRQ = Hi-z FOUT = Hi-z(OFF) VTEMP = Hi-z(OFF)	V <sub>DD</sub> =5 V	—	1.0	2.0	$\mu$ A
	I <sub>DD2</sub>	V <sub>DD</sub> =3 V		—	0.6	1.0	

Note) There is no VTEMP pin on the RTC-7301DG so standards for the VTEMP pin within the conditions described above do not apply.

■ Operating range GND = 0 V

Item	Symbol	Condition	Min.	Max.	Unit
Power voltage	V <sub>DD</sub>	—	2.4	5.5	V
Clock voltage	V <sub>CLK</sub>	—	1.6	—	—
Operating temperature	T <sub>OPR</sub>	No condensation	-40	+85	°C

■ Temperature sensor characteristics GND=0 V, T<sub>a</sub>= -40 °C to +85 °C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Temperature output voltage	V <sub>TEMP</sub>	T <sub>a</sub> =+25 °C, GND based output voltage VTEMP pins, V <sub>DD</sub> =2.7 V to 5.5 V	—	1.470	—	V
Output precision	T <sub>ACR</sub>	T <sub>a</sub> =+25 °C, V <sub>DD</sub> =2.7 V to 5.5 V	—	—	±5.0	°C
Temperature sensitivity	V <sub>SE</sub>	-40 °C ≤ T <sub>a</sub> ≤ +85 °C, V <sub>DD</sub> =2.7 V to 5.5 V	-7.3	-7.8	-8.3	mV / °C
Linearity	ΔNL	-40 °C ≤ T <sub>a</sub> ≤ +85 °C, V <sub>DD</sub> =2.7 V to 5.5 V	—	—	±2.0	%
Temperature detection range	T <sub>SOP</sub>	ΔNL ≤ ±2.0 %, V <sub>DD</sub> =2.7 V to 5.5 V	-40	—	+85	°C
Output resistance	R <sub>0</sub>	T <sub>a</sub> =25 °C, VTEMP pins, V <sub>DD</sub> =2.7 V to 5.5 V GND standard and V <sub>DD</sub> standard	—	1.0	3.0	kΩ
Load condition	C <sub>L</sub>	V <sub>DD</sub> =2.7 V to 5.5 V	—	—	100	pF
	R <sub>L</sub>	V <sub>DD</sub> =2.7 V to 5.5 V	—	—	500	kΩ
Response time	t <sub>RSP</sub>	V <sub>DD</sub> =3.3 V C <sub>L</sub> =50 pF, R <sub>L</sub> =500 kΩ, Max. ±1 °C	—	—	200	μs

Note) There is no temperature sensor function on the RTC-7301DG.

(\*) Please ask tighter tolerance

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In order to meet customer needs in a rapidly advancing digital, broadband and ubiquitous society, we are committed to offering products that are one step ahead of the market and a rank above the rest in quality. To achieve our goals, we follow a “3D (three device) strategy” designed to drive both horizontal and vertical growth. We will to grow our three device categories of “Timing Devices”, “Sensing Devices” and “Optical Devices”, and expand vertical growth through a combination of products from these categories.

A Quartz MEMS is any high added value quartz device that exploits the characteristics of quartz crystal material but that is produced using MEMS (micro-electro-mechanical system) processing technology.

Market needs are advancing faster than previously imagined toward smaller, more stable crystal products, but we will stay ahead of the curve by rolling out products that exceed market speed and quality requirements. We want to further accelerate the 3D strategy by QMEMS.

Quartz devices have become crucial in the network environment where products are increasingly intended for broadband, ubiquitous applications and where various types of terminals can transfer information almost immediately via LAN and WAN on a global scale. Epson Toyocom Corporation addresses every single aspect within a network environment. The new corporation offers “Digital Convergence” solutions to problems arising with products for consumer use, such as, core network systems and automotive systems.



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At Epson Toyocom, all environmental initiatives operate under the Plan-Do-Check-Action(PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer and global deforestation

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QS-9000 is an enhanced standard for quality assurance systems formulated by leading U.S. automobile manufacturers based on the international ISO 9000 series.

ISO/TS 16949 is a global standard based on QS-9000, a severe standard corresponding to the requirements from the automobile industry.

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	<ul style="list-style-type: none"> <li>► Pb free.</li> <li>► Complies with EU RoHS directive.</li> </ul>
	<ul style="list-style-type: none"> <li>► Pb free terminal designed. Contains Pb in products exempted by RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)</li> <li>► Complies with EU RoHS directive.</li> </ul>
	<ul style="list-style-type: none"> <li>► The products have been designed for high reliability applications such as Automotive.</li> </ul>

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